

## RELIABILITY TEST REPORT

## TESTITEM : 1.ELECTRICAL 2.MECHANICAL 3.ENV IRONMENTAL

SERIES NO. : CI06 Series Latch Type Wire to Board Conn.

TEST EQUIPMENT : 1.INSERTION & REMOVAL APPARATUS 2.ELECTRONIC MEASURING APPARATUS 3.ENVIRONMENTAL APPARATUS

DATE OF TESTING: 2005/10/04

TEST DEPART :R&D

TESTER : Sandy.kuan

**CONTAINT : ATTACHED** 



REVIEWED : <u>Alex</u> APPROVED : <u>David</u> VERIFIED : <u>Sandy</u>.



	ITEM	TEST CONDITION	REQUIREMENT	TEST RESULT	
1-1	Contact resistance	Dry circuit of DC 20 mV max.,100 mA max.	Less than 20 m $\Omega$	Sample	$20 \text{ m}\Omega \text{ max}.$
				1	5.00mΩ
				2	$4.78 \mathrm{m}\Omega$
				3	$4.85 \mathrm{m}\Omega$
				4	4.98mΩ
				5	4.75mΩ
1-2	Dielectric strength	When applied AC 800V 1 minute between adjacent	No change	Sample 1	800 V 1 minute
					OK
		terminal		2	OK
				3	OK
				4	OK
				5	OK
1-3	Insulation resistance	When applied DC 500 V	More than 1000 M $\Omega$	Sample	1000 MΩ min.
		between adjacent terminal		1	$3.0 \times 10^{5}$
		or ground		2	$3.7 \times 10^{5}$
				3	$3.0 \times 10^{5}$
				4	3.1×10 <sup>5</sup>
				5	$3.8 \times 10^{5}$

## 2. MECHANICAL PERFORMANCE :

	ITEM	TEST CONDITION	REQUIREMENT	TES	ST RESULT
2-1	Terminal crimp	When crimped AWG#24	AWG #24:	AWG #	24 AWG #30
	Tensile strength	size wire	3.0 Kgf Min.	4.28K	gf 1.40Kgf
		When crimped AWG#30	AWG #30:	4.39K	Ŭ Ŭ
		size wire		4.44K	0
			0.8 Kgf Min.	4.63K	0 0
2-2	Terminal insertion	Insertion speed 25± 3 mm	Less than 600gram	Sample	600gram max.
	force	per minute into housing		1	280 gram
		F		2	300 gram
				3	240 gram
				4	310 gram
				5	320 gram
2-3	Contact retaining Inse	Insertion speed 25± 3 mm	More than 1.5 Kgf	Sample	1.5 Kgf min.
	force in insulator	per minute into housing		1	2.72Kgf
		F		2	2.77Kgf
				3	2.77Kgf
				4	2.74Kgf
	~			5	2.56Kgf
2-4	Single contact	Measure force insertion	Less than 700gram	Sample	
	insertion force	using 0.50mm square pin at		1	290 gram
		speed $25 \pm 3$ mm per minute		2	260 gram
				3	270 gram
				4	290 gram
				5	250 gram



	ITEM	TEST CONDITION	REQUIREMENT	TES	ST RESULT
2-5	Single contact	Measure force withdrawal	More than 100gram	Sample	100 gram min.
2-5	withdrawal force	using 0.50mm square pin at	wore than roogram	1	240 gram
		speed $25\pm 3$ mm per minute		2	260 gram
		speed 25± 5 min per minute		3	230 gram
				4	260 gram
				5	220 gram
2-6	Durability	Connector shall be subjected to 100 cycles of insertion and withdrawal	Contact resistance:	Sample	C
			Less than twice of Initial	1	5.10 mΩ
				2	5.15 mΩ
				3	5.08 mΩ
				4	5.25 mΩ
				5	$5.10 \text{ m}\Omega$
2_7	Pin retention force	Push pin form insulator base	More than 1 0K of	Sample	1.0 Kgf min.
2-1		at speed $25 \pm 3$ mm per	Whole than 1.0Kgr	1	5.36 Kgf
		minute		2	5.57 Kgf
		minute		3	6.43 Kgf
				4	5.12 Kgf
				5	5.51 Kgf
28	receptacle without terminal at speed 25±3mm per minu (Test 16 Pin) Connector with latch shall be subjected to 500 cycles of insertion and withdrawa (Test 16 Pin) While withdrawing plug & receptacle without terminal at speed 25±3mm per minu (Test 2 Pin) Connector with latch shall be subjected to 500 cycles	While withdrawing plug & receptacle without terminal at speed 25±3mm per minute (Test 16 Pin)	Mana da a 5 OZ a f	-	
2-0			More than 5.0Kgf	Sample 1 2	5.0 Kgf Min. 8.94 Kgf
					8.16 Kgf
				3	8.94 Kgf
				4	8.54 Kgf
				5	8.61 Kgf
		Connactor with latch shall		Sample	5.0 Kgf Min.
		be subjected to 500 cycles of insertion and withdrawal		1	7.76 Kgf
				2	6.39 Kgf
				3	7.79 Kgf
				4	
			5	6.63 Kgf 6.33 Kgf	
		While withdrawing plug &	More than 1.0Kgf	Sample	1.0 Kgf Min.
		receptacle without terminal	More than 1.0Kgr		2.86 Kgf
				2	
				3	2.55 Kgf
		(Test 2 Fill)		-	2.03 Kgf
				4 5	2.76 Kgf
					2.63 Kgf
		be subjected to 500 cycles of insertion and withdrawal		Sample	1.0 Kgf Min.
				1	1.42 Kgf
				2	1.24 Kgf
				3	1.76 Kgf
				4	1.89 Kgf
				5	1.94 Kgf

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	ITEM	TEST CONDITION	REQUIREMENT	TES	ST RESULT
3-1	Solder ability	Soldering time:5±0.5second	Minimum:	Sample	90% min
		Soldering pot: 230±5°C	90% of immersed area	1	OK
				2	OK
				3	OK
				4	OK
				5	OK
3-2	Resistance to soldering	Soldering time:5±0.5second Soldering pot: 260±5°C	No change	Sample	No damage
				1	OK
				2	OK
				3	OK
				4	OK
				5	OK
3-3	Heat aging	85±2°C ,96 hours	No change	Sample	No damage
			-	1	OK
				2	OK
				3	OK
				4	ОК
				5	OK
-4	Humidity	40±2°C, 90-95%RH, 96	Appearance :	Sample	$40 \mathrm{m}\Omega \mathrm{max}$
		hours measurement must be taken within 30 min. after tested	No damage	1	7.4 mΩ
			Contact resistance:	2 3	7.9 mΩ
			Less than twice of initial		7.2 mΩ
				4	7.2 mΩ
				5	7.5 mΩ
			Dielectric strength: To pass area 8-3	Sample	800V 1minute
				1	OK
				2	OK
				3	OK
				4	OK
				5	OK
3-5	Temperature cycling	One cycle consists of: (1)-55 + $0/-3$ °C ,30 min.	Appearance: No	Sample	$40 \mathrm{m}\Omega$ max.
			damage	1	9.2 mΩ
		(2)Room temp. 10-15 min.	Contact resistance:	2	9.4 mΩ
		$(3)85 + 3/-0 \ ^{\circ}C$ , 30 min.	Less than twice of	3	9.5 mΩ
		(4)Room temp. 10-15 min.	initial	4	9.8 mΩ
				5	9.6 mΩ
0.1	Salt enrav	Temperature:35±3°C Solution:5±1% Spray time:48±4hours Measurement must be taken after water rinse	Appearance:		$40 \text{m} \Omega \text{ max}$
3-6	Salt spray		Appearance:	1	
			No damage Contact resistance: Less than twice of initial	1	<u>8.5 mΩ</u>
				2	8.6 mΩ
				3	8.7 mΩ
				4	8.5 mΩ
				5	$8.9 \text{ m}\Omega$